### PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
SANG KYUN KWON	05/25/2018
HAN WOOL RYU	05/25/2018
CHANG RYUL JUNG	05/25/2018
JONG HO CHUNG	05/25/2018
JONG SUK JEONG	05/25/2018
CHUL MIN SIM	05/25/2018

#### **RECEIVING PARTY DATA**

Name:	SAMSUNG ELECTRO-MECHANICS CO., LTD.	
Street Address:	reet Address: MAEYOUNG-RO 150 (MAETAN-DONG), YOUNGTONG-GU	
City:	suwon-si, gyeonggi-do	
State/Country:	e/Country: KOREA, REPUBLIC OF	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16008928

#### **CORRESPONDENCE DATA**

**Fax Number:** (202)756-8087

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 202-756-8000

**Email:** rfeimster@mwe.com, ipdocketmwe@mwe.com,

wdcipptsclerks@mwe.com

Correspondent Name: HOSANG LEE

Address Line 1: MCDERMOTT WILL & EMERY LLP
Address Line 2: 500 NORTH CAPITOL STREET, N.W.

Address Line 4: WASHINGTON, D.C. 20001

ATTORNEY DOCKET NUMBER:	097821-1197
NAME OF SUBMITTER:	HOSANG LEE
SIGNATURE:	/Hosang Lee/
DATE SIGNED:	08/07/2018

**Total Attachments: 3** 

PATENT REEL: 046568 FRAME: 0419 source=097821\_1197\_Executed\_Assignment#page1.tif source=097821\_1197\_Executed\_Assignment#page2.tif source=097821\_1197\_Executed\_Assignment#page3.tif

> PATENT REEL: 046568 FRAME: 0420

# COMBINED DECLARATION AND ASSIGNMENT FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

I believe I am the original or an original joint inventor of a claimed invention in the application for which a patent is sought on the invention entitled:

# FE-BASED NANOCRYSTALLINE ALLOY AND ELECTRONIC COMPONENT USING THE SAME

wnich	application is:
X	attached, or
	United States application number or PCT international application number filed on
The at	ove-identified application was made or authorized to be made by me.
execut reques	event that the filing date and/or application number are not entered above at the time I e this document, and if such information is deemed necessary, I hereby authorize and the registered practitioners of <b>McDermott Will &amp; Emery LLP</b> , associated with the ner Number 20277, to insert above the filing date and/or application number of the ation.
I hereb	by acknowledge that any willful false statement made in this declaration is punishable  18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both

#### <u>ASSIGNMENT</u>

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign to

## SAMSUNG ELECTRO-MECHANICS CO., LTD.

having an address at Macyoung-Ro 150 (Maetan-Dong), Youngtong-Gu, Suwon-Si, Gyeonggi-Do, Republic of Korea

hereinafter designated as the Assignee, the entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention described in the application identified in this document.

I hereby confirm any prior assignment to Assignee, and to the extent that I have not already done so, agree to assign, and hereby do, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by the undersigned had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights:

I hereby covenant and agree to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

I hereby covenant that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment.

Page 2 of 3

Legal name of first inventor	
Sang Kyun KWON	
First inventor's signature	Date
//	May 25th, 201
	May 25th, 201
Legal name of second inventor	
Han Wool RYU	
Second inventor's signature	Date
Mary Jan	Man or al and
	May 25 e4, 2018
Legal name of third inventor	· · · · · · · · · · · · · · · · · · ·
Chang Ryul JUNG	
Third inventor's signature	Date
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* // /h	May 2582, 2018
L. Marie Carlotte Control of the Con	The state of the s
Legal name of fourth inventor	
Jong Ho CHUNG	
Fourth inventor's signature	Date
Many Typt	May 25th, 2018
Court office	1014y -sun, -010
	· · · · · · · · · · · · · · · · · · ·
Legal name of fifth inventor	
Jong Suk JEONG	
Fifth inventor's signature	Date
m m h	May 25th, 2018
	My mm. ma
Legal name of sixth inventor	
Chul Min SIM	
Sixth inventor's signature	Date
N. A. W.	100, 241, 210
	May 25th, 2018